

Electronic Acknowledgement Receipt

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Title of Invention:	SINTERED SEMICONDUCTOR MATERIAL
First Named Inventor/Applicant Name:	Alain Straboni
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Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Transmittal Letter	00047364.PDF	35269	no	2
			25a2819f316e1abc4749c4929d36dc60a2c8d41b		
Warnings:					
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2	Information Disclosure Statement (IDS) Filed (SB/08)	00047326.PDF	612830	no	4
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Warnings:					
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3	Foreign Reference	00047318.PDF	238567	no	11
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Information:					
4	Foreign Reference	00047320.PDF	1530350	no	36
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5	Foreign Reference	00047321.PDF	238057	no	6
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6	NPL Documents	00047319.PDF	28112	no	2
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Information:					
7	Request for Continued Examination (RCE)	00047351.PDF	697845	no	3
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8	Fee Worksheet (PTO-875)	fee-info.pdf	30163	no	2
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